RENESAS

X9421

NOT RECOMMENDED FOR NEW DESIGNS POSSIBLE SUBSTITUTE PRODUCT ISL22416, ISL22419

Low Noise/Low Power/SPI Bus Single Digitally Controlled (XDCP™) Potentiometer

Description

The X9421 integrates a single digitally controlled potentiometer (XDCP) on a monolithic CMOS integrated circuit.

The digital controlled potentiometer is implemented using 63 resistive elements in a series array. Between each element are tap points connected to the wiper terminal through switches. The position of the wiper on the array is controlled by the user through the SPI bus interface. The potentiometer has associated with it a volatile Wiper Counter Register (WCR) and a four non-volatile Data Registers that can be directly written to and read by the user. The contents of the WCR controls the position of the wiper on the resistor array though the switches. Power-up recalls the contents of the default data register (DR0) to the WCR.

The XDCP can be used as a three-terminal potentiometer or as a two terminal variable resistor in a wide variety of applications including control, parameter adjustments, and signal processing.

Features

- Single Voltage Potentiometer
- 64 Resistor Taps
- SPI Serial Interface for Write, Read, and Transfer Operations of the Potentiometer
- Wiper Resistance, 150Ω Typical at 5V
- · 4 Non-Volatile Data Registers
- · Non-Volatile Storage of Multiple Wiper Positions
- Power-on Recall. Loads Saved Wiper Position on Power-up.
- Standby Current < 5µA Max
- V_{CC}: 2.7V to 5.5V Operation
- 2.5k Ω , 10k Ω End to End Resistance
- · 100 yr. Data Retention
- · Endurance: 100, 000 Data Changes per Bit per Register
- 14 Ld TSSOP, 16 Ld SOIC
- Low Power CMOS
- Pb-Free Available (RoHS Compliant)



Block Diagram

1-888-INTERSIL or 1-888-468-3774 | Intersil (and design) is a registered trademark of hereicas Inc. 2005, 2008, 2009. All Rights Reserved All other trademarks mentioned are the property of their respective owners.

DATASHEET

FN8196 Rev.1.00 January 14, 2009

Ordering Information

| PART NUMBER | PART MARKING | V _{CC} LIMITS (V) | POTENTIOMETER ORGANIZATION (kΩ) | TEMP RANGE (°C) | PACKAGE |
|----------------------------|-----------------|-------------------------------|---------------------------------------|--------------------|--------------------------------|
| X9421YS16* | X9421YS | 5 ±10% | 2.5 | 0 to +70 | 16 Ld SOIC (300 mil) |
| X9421YS16Z* (Note) | X9421YS Z | _ | | 0 to +70 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421YS16I* | X9421YS I | _ | | -40 to +85 | 16 Ld SOIC (300 mil) |
| X9421YS16IZ* (Note) | X9421YS ZI | _ | | -40 to +85 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421YV14* | X9421 YV | _ | | 0 to +70 | 14 Ld TSSOP (4.4mm) |
| X9421YV14Z* (Note) | X9421 YVZ | _ | | 0 to +70 | 14 Ld TSSOP (4.4mm) (Pb-Free) |
| X9421YV14I* | X9421 YV I | _ | | -40 to +85 | 14 Ld TSSOP (4.4mm) |
| X9421YV14IZ* (Note) | X9421 YVZI | _ | | -40 to +85 | 14 Ld TSSOP (4.4mm) (Pb-Free) |
| X9421WS16* | X9421WS | _ | 10 | 0 to +70 | 16 Ld SOIC (300 mil) |
| X9421WS16Z* (Note) | X9421WS Z | _ | | 0 to +70 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421WS16I* | X9421WS I | _ | | -40 to +85 | 16 Ld SOIC (300 mil) |
| X9421WS16IZ* (Note) | X9421WS ZI | _ | | -40 to +85 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421WV14* | X9421 WV | _ | | 0 to +70 | 14 Ld TSSOP (4.4mm) |
| X9421WV14Z* (Note) | X9421 WV Z | _ | | 0 to +70 | 14 Ld TSSOP (4.4mm) (Pb-Free) |
| X9421WV14I* | X9421 WV I | _ | | -40 to +85 | 14 Ld TSSOP (4.4mm) |
| X9421WV14IZ* (Note) | X9421 WVZI | _ | | -40 to +85 | 14 Ld TSSOP (4.4mm) (Pb-Free) |
| X9421YS16-2.7* | X9421YS F | 2.7 to 5.5 | 2.5 | 0 to +70 | 16 Ld SOIC (300 mil) |
| X9421YS16Z-2.7* (Note) | X9421YS ZF | _ | | 0 to +70 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421YS16I-2.7* | X9421 YS G | _ | | -40 to +85 | 16 Ld SOIC (300 mil) |
| X9421YS16IZ-2.7* (Note) | X9421 YS ZG | _ | | -40 to +85 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421YV14-2.7* | X9421 YVF | _ | | 0 to +70 | 14 Ld TSSOP (4.4mm) |
| X9421YV14Z-2.7* (Pb-free) | X9421 YVZF | _ | | 0 to +70 | 14 Ld TSSOP (4.4mm) (Pb-Free) |
| X9421YV14I-2.7* | X9421 YVG | _ | | -40 to +85 | 14 Ld TSSOP (4.4mm) |
| X9421YV14IZ-2.7* (Pb-free) | X9421 YVZG | _ | | -40 to +85 | 14 Ld TSSOP (4.4mm) (Pb-Free) |
| X9421WS16-2.7* | X9421WS F | _ | 10 | 0 to +70 | 16 Ld SOIC (300 mil) |
| X9421WS16Z-2.7* (Note) | X9421WS ZF | _ | | 0 to +70 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421WS16I-2.7* | X9421WS G | _ | | -40 to +85 | 16 Ld SOIC (300 mil) |
| X9421WS16IZ-2.7* (Note) | X9421WS ZG | 1 | | -40 to +85 | 16 Ld SOIC (300 mil) (Pb-Free) |
| X9421WV14-2.7* | X9421 WVF | 1 | | 0 to +70 | 14 Ld TSSOP (4.4mm) |
| X9421WV14Z-2.7* (Pb-free) | X9421 WVZF | - | | 0 to +70 | 14 Ld TSSOP (4.4mm) (Pb-Free) |
| X9421WV14I-2.7* | X9421 WVG | - | | -40 to +85 | 14 Ld TSSOP (4.4mm) |
| X9421WV14IZ-2.7* (Pb-free) | X9421 WVZG | - | | -40 to +85 | 14 Ld TSSOP (4.4mm) (Pb-Free |

*Add "T1" suffix for tape and reel. Please refer to TB347 for details on reel specifications.

NOTE: These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020

Detailed Functional Diagrams



Circuit Level Applications

- · Vary the Gain of a Voltage Amplifier
- Provide Programmable DC Reference Voltages for Comparators and Detectors
- · Control the Volume in Audio Circuits
- Trim Out the Offset Voltage Error in a Voltage Amplifier Circuit
- · Set the Output Voltage of a Voltage Regulator
- Trim the Resistance in Wheatstone Bridge Circuits
- Control the Gain, Characteristic Frequency and Q-factor in Filter Circuits
- Set the Scale Factor and Zero Point in Sensor Signal Conditioning Circuits
- · Vary the Frequency and Duty Cycle of Timer ICs
- · Vary the DC Biasing of a Pin Diode Attenuator in RF Circuits
- Provide a Control Variable (I, V, or R) in Feedback Circuits

System Level Applications

- · Adjust the contrast in LCD displays
- Control the Power Level of LED Transmitters in Communication Systems
- Set and Regulate the DC Biasing Point in an RF Power Amplifier in Wireless Systems
- · Control the Gain in Audio and Home Entertainment Systems
- Provide the Variable DC Bias for Tuners in RF Wireless
 Systems
- Set the Operating Points in Temperature Control Systems
- Control the Operating Point for Sensors in Industrial Systems
- Trim Offset and Gain Errors in Artificial Intelligent Systems





Pin Assignments

| TSSOP PIN NO. | SOIC PIN NO. | SYMBOL | DESCRIPTION |
|------------------|-----------------|--------------------------------|--------------------------------------|
| 1 | 2 | SO | Serial Data Output |
| 2, 3 | 3, 1, 7, 5 | NC | No Connect |
| 4 | 4 | CS | Chip Select |
| 5 | 5 | SCK | Serial Clock |
| 6 | 6 | SI | Serial Data Input |
| 7 | 8 | VSS | System Ground |
| 8 | 9 | WP | Hardware Write Protect |
| 9 | 10 | A0 | Device Address |
| 10 | | HOLD | Device select. Pause the serial bus. |
| 11 | 12 | R _W /V _W | Wiper Terminal of the Potentiometer. |
| 12 | 13 | R _H /V _H | High Terminal of the Potentiometer. |
| 13 | 14 | R _L /V _L | Low Terminal of the Potentiometer. |
| 14 | 16 | VCC | System Supply Voltage |

Pin Descriptions

Host Interface Pins

SERIAL OUTPUT (SO)

SO is a push/pull serial data output pin. During a read cycle, data is shifted out on this pin. Data is clocked out by the falling edge of the serial clock.

SERIAL INPUT

SI is the serial data input pin. All opcodes, byte addresses and data to be written to the potentiometer and pot register are input on this pin. Data is latched by the rising edge of the serial clock.

SERIAL CLOCK (SCK)

The SCK input is used to clock data into and out of the X9421.

CHIP SELECT (\overline{CS})

When $\overline{\text{CS}}$ is HIGH, the X9421 is deselected and the SO pin is at high impedance, and (unless an internal write cycle is

underway) the device will be in the standby state. \overline{CS} LOW enables the X9421, placing it in the active power mode. It should be noted that after a power-up, a HIGH to LOW transition on \overline{CS} is required prior to the start of any operation.

HOLD (HOLD)

HOLD is used in conjunction with the \overline{CS} pin to select the device. Once the part is selected and a serial sequence is underway, HOLD may be used to pause the serial communication with the controller without resetting the serial sequence. To pause, HOLD must be brought LOW while SCK is LOW. To resume communication, HOLD is brought HIGH, again while SCK is LOW. If the pause feature is not used, HOLD should be held HIGH at all times.

DEVICE ADDRESS (A₀)

The address input is used to set the least significant bit of the 8-bit slave address. A match in the slave address serial data stream must be made with the address input in order to initiate



communication with the X9421. A maximum of two devices may occupy the SPI serial bus.

Potentiometer Pins

$V_H/R_H, V_L/R_L$

The V_H/R_H and V_L/R_L inputs are equivalent to the terminal connections on either end of a mechanical potentiometer.

V_W/R_W

The wiper output is equivalent to the wiper output of a mechanical potentiometer.

HARDWARE WRITE PROTECT INPUT (WP)

The $\overline{\text{WP}}$ pin when LOW prevents nonvolatile writes to the Data Registers. Writing to the Wiper Counter Register is not restricted.

SYSTEM/DIGITAL SUPPLY (V_{CC})

VCC is the supply voltage for the system/digital section. VSS is the system ground.

Principles of Operation

The X9421 is a highly integrated microcircuit incorporating a resistor array and associated registers and counter and the serial interface logic providing direct communication between the host and the XDCP potentiometer.

Serial Interface

The X9421 supports the SPI interface hardware conventions. The device is accessed via the SI input with data clocked in on the rising SCK. \overline{CS} must be LOW and the HOLD and \overline{WP} pins must be HIGH during the entire operation.

The SO and SI pins can be connected together, since they have three state outputs. This can help to reduce system pin count.

Array Description

The X9421 is comprised of one resistor array containing 63 discrete resistive segments that are connected in series. The physical ends of each array are equivalent to the fixed terminals of a mechanical potentiometer (V_H/R_H and V_L/R_L inputs).

At both ends of the array and between each resistor segment is a CMOS switch connected to the wiper (V_W/R_W) output. Within the individual array only one switch may be turned on at a time.

These switches are controlled by a Wiper Counter Register (WCR). The six bits of the WCR are decoded to select, and enable, one of sixty-four switches. The block diagram of the potentiometer is shown in Figure 1.

Wiper Counter Register (WCR)

The X9421 contains a Wiper Counter Register. The WCR can be envisioned as a 6-bit parallel and serial load counter with its outputs decoded to select one of sixty-four switches along its resistor array. The contents of the WCR can be altered in four



ways: it may be written directly by the host via the Write Wiper Counter Register instruction (serial load); it may be written indirectly by transferring the contents of one of four associated Data Registers via the XFR Data Register instruction (parallel load); it can be modified one step at a time by the Increment/Decrement instruction. Finally, it is loaded with the contents of its data register zero (DR0) upon power-up.

The Wiper Counter Register is a volatile register; that is, its contents are lost when the X9421 is powered-down. Although the register is automatically loaded with the value in DR0 upon power-up, this may be different from the value present at power-down.

Data Registers

The potentiometer has four 6-bit nonvolatile Data Registers. These can be read or written directly by the host. Data can also be transferred between any of the four Data Registers and the WCR. It should be noted all operations changing data in one of the Data Registers is a nonvolatile operation and will take a maximum of 10ms.

If the application does not require storage of multiple settings for the potentiometer, the Data Registers can be used as regular memory locations for system parameters or user preference data.

Register Descriptions

TABLE 1. DATA REGISTERS, (6-BIT), NONVOLATILE

| 0 | 0 | D5 | D4 | D3 | D2 | D1 | D0 |
|------|-----|----|----|----|----|-----|-----|
| (M\$ | SB) | | | | | (LS | SB) |

There are four 6-bit Data Registers associated with the potentiometer.

 {D5~D0}: These bits are for general purpose Nonvolatile data storage or for storage of up to four different wiper values.

TABLE 2. WIPER COUNTER REGISTER, (6-BIT), VOLATILE

| 0 | 0 | WP5 | WP4 | WP3 | WP2 | WP1 | WP0 |
|-----|-----|-----|-----|-----|-----|-----|-----|
| (MS | SB) | | | | | (LS | SB) |

• {WP5~WP0}: These bits specify the wiper position of the potentiometer.



Write In Process

The contents of the Data Registers are saved to nonvolatile memory when the \overline{CS} pin goes from LOW to HIGH after a complete write sequence is received by the device. The progress of this internal write operation can be monitored by a Write In Process bit (WIP). The WIP bit is read with a Read Status command.



DEVICE ADDRESS

FIGURE 2. ADDRESS/IDENTIFICATION BYTE FORMAT

Instruction Byte

The next byte sent to the X9421 contains the instruction and register pointer information. The four most significant bits are the instruction. The next two bits point to one of four Data Registers. The format is shown below in Figure 3.



INSTRUCTIONS



The four high order bits of the instruction byte specify the operation. The next two bits (R_1 and R_0) select one of the four registers that is to be acted upon when a register oriented instruction is issued. The last two bits are defined as 0.

Instructions

Address/Identification (ID) Byte

The first byte sent to the X9421 from the host, following a \overline{CS} going HIGH to LOW, is called the Address or Identification byte. The most significant four bits of the slave address are a device type identifier, for the X9421 this is fixed as 0101[B] (refer to Figure 2).

The least significant bit in the ID byte selects one of two devices on the bus. The physical device address is defined by the state of the A₀ input pin. The X9421 compares the serial data stream with the address input state; a successful compare of the address bit is required for the X9421 to successfully continue the command sequence. The A₀ input can be actively driven by a CMOS input signal or tied to V_{CC} or V_{SS}.

The remaining three bits in the ID byte must be set to 110.



Two of the eight instructions are two bytes in length and end with the transmission of the instruction byte. These instructions are:

- <u>XFR Data Register to Wiper Counter Register</u> This instruction transfers the contents of one specified Data Register to the Wiper Counter Register.
- <u>XFR Wiper Counter Register to Data Register</u>—This instruction transfers the contents of the Wiper Counter Register to the specified associated Data Register.

The basic sequence of the two byte instructions is illustrated in Figure 4. These two-byte instructions exchange data between the WCR and one of the Data Registers. A transfer from a Data Register to a WCR is essentially a write to a static RAM, with the static RAM controlling the wiper position. The response of the wiper to this action will be delayed by t_{WRL} . A transfer from the WCR (current wiper position), to a Data Register is a write to nonvolatile memory and takes a minimum of t_{WR} to complete. The transfer can occur between the potentiometer and one of its associated registers.

Five instructions require a three-byte sequence to complete. These instructions transfer data between the host and the X9421; either between the host and one of the Data Registers or directly between the host and the WCR. These instructions are:

- <u>Read Wiper Counter Register</u>—read the current wiper position of the pot,
- <u>Write Wiper Counter Register</u>—change current wiper position of the pot,
- <u>Read Data Register</u>—read the contents of the selected data register;
- <u>Write Data Register</u>—write a new value to the selected data register.
- <u>Read Status</u>—This command returns the contents of the WIP bit which indicates if the internal write cycle is in progress.

The sequence of these operations is shown in Figure 5 and Figure 6.

The final command is Increment/Decrement. It is different from the other commands, because it's length is indeterminate. Once the command is issued, the master can clock the wiper up and/or down in one resistor segment step; thereby, providing a fine tuning capability to the host. For each SCK clock pulse (t_{HIGH}) while SI is HIGH, the selected wiper will move one resistor segment towards the V_H/R_H terminal. Similarly, for each SCK clock pulse while SI is LOW, the selected wiper will move one resistor segment towards the V_L/R_L terminal. A detailed illustration of the sequence and timing for this operation are shown in Figure 7 and 8.



FIGURE 4. TWO-BYTE INSTRUCTION SEQUENCE



FIGURE 5. THREE-BYTE INSTRUCTION SEQUENCE (WRITE)







FIGURE 7. INCREMENT/DECREMENT INSTRUCTION SEQUENCE



FIGURE 8. INCREMENT/DECREMENT TIMING LIMITS

| | | | | ٦ | ABLE | 3. INS | STRUC | TION | SET |
|--|----------------|----------------|----------------|----------------|----------------|----------------|-------|------|--|
| | | | IN | STRU | CTION | I SET | | | |
| INSTRUCTION | l ₃ | l ₂ | I ₁ | I ₀ | R ₁ | R ₀ | | | OPERATION |
| Read Wiper Counter Register | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | Read the contents of the Wiper Counter Register |
| Write Wiper Counter Register | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | Write new value to the Wiper Counter Register |
| Read Data Register | 1 | 0 | 1 | 1 | 1/0 | 1/0 | 0 | 0 | Read the contents of the Data Register pointed to by $R_1 - R_0$ |
| Write Data Register | 1 | 1 | 0 | 0 | 1/0 | 1/0 | 0 | 0 | Write new value to the Data Register pointed to by ${\rm R_1}$ - ${\rm R_0}$ |
| XFR Data Register to Wiper Counter Register | 1 | 1 | 0 | 1 | 1/0 | 1/0 | 0 | 0 | Transfer the contents of the Data Register pointed to by R_1 - R_0 to the Wiper Counter Register |
| XFR Wiper Counter Register to Data Register | 1 | 1 | 1 | 0 | 1/0 | 1/0 | 0 | 0 | Transfer the contents of the Wiper Counter Register to the Data Register pointed to by $R_1 - R_0$ |
| Increment/Decrement Wiper Counter Register | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | Enable Increment/decrement of the Wiper Counter Register |
| Read Status (WIP bit) | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | Read the status of the internal write cycle, by checking the WIP bit. |

Instruction Format

NOTES:

- 1. "A0": stands for the device addresses sent by the master.
- 2. WPx refers to wiper position data in the Wiper Counter Register"I": stands for the increment operation, SI held HIGH during active SCK phase (high).
- 3. "D": stands for the decrement operation, SI held LOW during active SCK phase (high).

Read Wiper Counter Register (WCR)

| | DEV TYF IDENT | ΡE | | AI | | VIC RES | E SES | | STRI OPC | | | | | | | | | (S | | R POSI Y X9421 | | D) | | CS RISING |
|------|---------------------|----|---|----|---|------------|----------|---|-------------|---|---|---|---|---|---|---|---|-----|-----|-------------------|-----|------------|-----|--------------|
| EDGE | 0 1 | 0 | 1 | 1 | 1 | 0 | A0 | 1 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | WP5 | WP4 | WP3 | WP2 | WP1 | WP0 | EDGE |

Write Wiper Counter Register (WCR)

| | IDE | DEV TYF ENT | ΡE | | A | | EVIC RES | E SES | | STRI OPC | | ION E | | | | | | | (| DA SENT B | ATA BY SY HOS | | I) | | CS RISING |
|------|-----|-------------------|----|---|---|---|-------------|----------|---|-------------|---|----------|---|---|---|---|---|---|-----|--------------|------------------|-----|-----|-----|--------------|
| EDGE | 0 | 1 | 0 | 1 | 1 | 1 | 0 | A0 | 1 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | WP5 | WP4 | WP3 | WP2 | WP1 | WP0 | EDGE |

Read Data Register (DR)

Read the contents of the Register pointed to by R1 - R0.

| | DEVICE TYPE IDENTIFIER | DEVICE ADDRESSES | INSTRUCTION OPCODE | REGISTER ADDRESSES | DATA BYTE (SENT BY X9421 ON SO) | |
|------|------------------------------|---------------------|-----------------------|-----------------------|------------------------------------|------|
| EDGE | 0 1 0 1 | 1 1 0 A0 | 1 0 1 1 | R1 R0 0 0 | 0 0 WP5 WP4 WP3 WP2 WP1 WP0 | EDGE |

Write Data Register (DR)

Write a new value to the Register pointed to by R1 - R0.

| cs | | DEV TY EN1 | ΡE | | | DEV DRE | 'ICE Essi | | | STRI OPC | | | | EGI | - | | | | (SEI | | ta by Y hos | TE ST ON | SI) | | cs | |
|-----------------|---|------------------|----|---|---|------------|--------------|--------|---|-------------|---|---|--------|--------|---|---|---|---|---------|---------|----------------|-------------|---------|---------|----------------|-----------------------------|
| FALLING EDGE | 0 | 1 | 0 | 1 | 1 | 1 | 0 | A 0 | 1 | 1 | 0 | 0 | R 1 | R 0 | 0 | 0 | 0 | 0 | WP 5 | WP 4 | WP 3 | WP 2 | WP 1 | WP 0 | RISING EDGE | HIGH-VOLTAGE WRITE CYCLE |



Transfer Data Register (DR) to Wiper Counter Register (WCR)

Transfer the contents of the Register pointed to by R1 - R0 to the WCR.

| | | ΤY | /ICE PE TIFIE | - | A | | VIC | E SES | | STRI OPC | | | | EGIS DRE | | | CS RISING |
|------|---|----|---------------------|---|---|---|-----|----------|---|-------------|---|---|----|-------------|---|---|--------------|
| EDGE | 0 | 1 | 0 | 1 | 1 | 1 | 0 | A0 | 1 | 1 | 0 | 1 | R1 | R0 | 0 | 0 | EDGE |

Transfer Wiper Counter Register (WCR) to Data Register (DR)

| CS FALLIN | | ΤY | /ICE PE TIFIE | - | AI | | VICI | E SES | | | JCTI ODE | | | EGIS DRE | | - | CS RISING | HIGH-VOLTAGE |
|--------------|---|----|---------------------|---|----|---|------|----------|---|---|-------------|---|----|-------------|---|---|--------------|--------------|
| G EDGE | 0 | 1 | 0 | 1 | 1 | 1 | 0 | A0 | 1 | 1 | 1 | 0 | R1 | R0 | 0 | 0 | EDGE | WRITE CYCLE |

Increment/Decrement Wiper Counter Register (WCR)

| CS FALLING | | VICI ENT | | | Α | | VIC | E SES | | STRL OPC | | | | | | | | | | | MENT N SD/ | | CS RISING |
|---------------|---|-------------|---|---|---|---|-----|----------|---|-------------|---|---|---|---|---|---|-----|-----|------|---|-------------------|-----|--------------|
| EDGE | 0 | 1 | 0 | 1 | 1 | 1 | 0 | A0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | I/D | I/D | • | • | I/D | I/D | EDGE |

Read Status

| cs | | ΤY | /ICE PE TIFIE | - | A | | VICI | E SES | - | | JCTI ODE | | | | | | (| SEN | | | BY1 9421 | | ISC |)) | cs |
|-----------------|---|----|---------------------|---|---|---|------|----------|---|---|-------------|---|---|---|---|---|---|-----|---|---|-------------|---|-----|---------|----------------|
| FALLING EDGE | 0 | 1 | 0 | 1 | 1 | 1 | 0 | A0 | 0 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | W IP | RISING EDGE |

Absolute Maximum Ratings

Supply Voltage (V_{CC} Limits)

| X9421 | 5V ±10% |
|--|--------------|
| X9421-2.7 | 2.7V to 5.5V |
| Voltage on SCK, SDA any address input | |
| with respect to V _{SS} : | 1V to +7V |
| $\Delta V = (V_{H} - V_{L}) \dots \dots$ | |
| I _W (10s) | ±6mA |
| Any VH/RH, VL/RL, VW/RW | VSS to VCC |
| | |

Thermal Information

| Thermal Resistance (Typical, Note 1) | θ _{JA} (°C/W) |
|--|------------------------|
| 14 Lead TSSOP | 92 |
| 16 Lead SOIC | 82 |
| Temperature Under Bias | C to +135°C |
| Storage Temperature | C to +150°C |
| Pb-Free Reflow Profilese | e link below |
| http://www.intersil.com/pbfree/Pb-FreeReflow.asp | |

Operating Conditions

| Temperature | Range |
|-------------|-------|
|-------------|-------|

| Commercial | - | 0°C to +70°C |
|------------|---|---------------|
| Industrial | | 40°C to +85°C |

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

1. θ_{JA} is measured with the component mounted on a low effective thermal conductivity test board in free air. See Tech Brief TB379 for details

| | | | LIMITS | | | | | | |
|--|--|--|------------------|------------------|-------------------------|-------------|--|--|--|
| SYMBOL | PARAMETER | TEST CONDITIONS | MIN. (Note 5) | TYP. (Note 6) | MAX. (Note 5) | UNITS | | | |
| Rtotal | End to End Resistance Tolerance | | -20 | | +20 | % | | | |
| | Power Rating | +25°C, each pot | | | 50 | mW | | | |
| R _W | Wiper Resistance | Wiper Current lw = $(V_H - V_L)/R_{TOTAL}, V_{CC} = 5V$ | | 150 | 250 | Ω | | | |
| | | Wiper Current $Iw = (V_H - V_L)/R_{TOTAL}, V_{CC} = 3V$ | | 400 | 1000 V _{CC} | Ω | | | |
| V _{TERM} | Voltage on any V_H/R_H , V_L/R_L , V_W/R_W | V _{SS} = 0V | V _{SS} | | V _{CC} | V | | | |
| | Noise | Ref: 1kHz | | -120 | | dBV | | | |
| | Resolution (Note 4) | (Note 5) | | 1.6 | | % | | | |
| | Absolute Linearity (Note 1) | Vw(n)(actual) - Vw(n)(expected) | -1 | | +1 | MI (Note 3) | | | |
| | Relative Linearity (Note 2) | V _{w(n + 1)} - [V _{w(n)} + MI] | -0.2 | | +0.2 | MI (Note 3) | | | |
| | Temperature Coefficient of R _{TOTAL} | (Note 5) | | ±300 | | ppm/°C | | | |
| | Ratio metric Temperature Coefficient | (Note 5) | | ±20 | | ppm/°C | | | |
| C _H /C _L /C _W | Potentiometer Capacitances | See "Circuit #3 SPICE Macro Model" on page 13 | | 10/10/25 | | pF | | | |
| I _{AL} | Rh, RI, Rw leakage current | VIN = VSS to VCC. Device is in stand-by mode. | | 0.1 | 10 | μA | | | |

Analog Specifications (Over recommended operating conditions unless otherwise stated.)

| | | | LIMITS | | | | | | |
|------------------|---|---|-----------------------|-----------------|-----------------------|-------|--|--|--|
| SYMBOL | PARAMETER | TEST CONDITIONS | MIN (Note 5) | TYP (Note 6) | MAX (Note 5) | UNITS | | | |
| I _{CC1} | V _{CC} Supply Current (Active) | f _{SCK} = 2MHz, SO = Open, Other Inputs = V _{SS} | | | 400 | μA | | | |
| I _{CC2} | V _{CC} Supply Current (Nonvolatile Write) | f _{SCK} = 2MHz, SO = Open, Other Inputs = V _{SS} | | | 3.5 | mA | | | |
| I _{SB} | V _{CC} Current (Standby) | SCK = SI = V_{SS} , Addr. = V_{SS} | | | 3 | μA | | | |
| ILI | Input Leakage Current | V_{IN} = V_{SS} to V_{CC} | | | 10 | μA | | | |
| I _{LO} | Output Leakage Current | V_{OUT} = V_{SS} to V_{CC} | | | 10 | μA | | | |
| VIH | Input HIGH Voltage | | V _{CC} x 0.7 | | V _{CC} + 0.3 | V | | | |
| VIL | Input LOW Voltage | | -0.5 | | V _{CC} x 0.1 | V | | | |
| V _{OL} | Output LOW Voltage | I _{OL} = 3mA | | | 0.4 | V | | | |

DC Electrical Specifications (Over the recommended operating conditions unless otherwise specified).

ENDURANCE AND DATA RETENTION

| PARAMETER | MIN | UNITS |
|-------------------|---------|-----------------------------------|
| Minimum Endurance | 100,000 | Data Changes per Bit per Register |
| Data Retention | 100 | Years |

CAPACITANCE

| SYMBOL | TEST | ТҮР | UNITS | TEST CONDITIONS |
|---------------------------|-------------------------------------|-----|-------|-----------------------|
| C _{OUT} (Note 5) | Output Capacitance (SO) | 8 | pF | V _{OUT} = 0V |
| C _{IN} (Note 5) | Input Capacitance (A0, SI, and SCK) | 6 | pF | V _{IN} = 0V |

POWER-UP TIMING

| SYMBOL | PARAMETER | MIN | MAX | UNITS |
|---|-------------------------------|-----|-----|--------|
| t _R V _{CC} (Note 5) | V _{CC} Power-up Ramp | 0.2 | 50 | V/msec |

NOTES:

1. Absolute Linearity is utilized to determine actual wiper voltage versus expected voltage as determined by wiper position when used as a potentiometer.

2. Relative Linearity is utilized to determine the actual change in voltage between two successive tap positions when used as a potentiometer. It is a measure of the error in step size.

- 3. MI = RTOT/63 or $(V_H V_L)/63$, single pot
- 4. Typical = Individual array resolution.
- 5. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.
- 6. Limits should be considered typical and are not production tested.
- 7. This parameter is not production tested. Parameter established by characterization.

Power-up Requirements

(Power-up sequencing can affect correct recall of the wiper registers) The preferred power-on sequence is as follows: First V_{CC} and then the potentiometer pins, R_H, R_L, and R_W. Voltage should not be applied to the potentiometer pins before V_{CC} is applied. The V_{CC} ramp rate specification should be met, and any glitches or slope changes in the V_{CC} line should be held to <100mV if possible. Also, V_{CC} should not reverse polarity by

more than 0.5V. Recall of wiper position will not be complete until V_{CC} reaches its final value.



AC Test Conditions

| Input pulse levels | V _{CC} x 0.1 to V _{CC} x 0.9 |
|-------------------------------|--|
| Input rise and fall times | 10ns |
| Input and output timing level | V _{CC} x 0.5 |

Equivalent AC Load Circuit



Circuit #3 SPICE Macro Model





AC Timing

| SYMBOL | PARAMETER | MIN (Note 5) | TYP (Note 6) | MAX (Note 5) | UNITS |
|--------------------------------|--|-----------------|-----------------|-----------------|-------|
| fSCK | SSI/SPI Clock Frequency | | | 2.0 | MHz |
| tCYC | SSI/SPI Clock Cycle Time | 500 | | | ns |
| t _{WH} | SSI/SPI Clock High Time | 200 | | | ns |
| t _{WL} | SSI/SPI Clock Low Time | 200 | | | ns |
| t _{LEAD} | Lead Time | 250 | | | ns |
| t _{LAG} | Lag Time | 250 | | | ns |
| t _{SU} | SI, SCK, HOLD and CS Input Setup Time | 50 | | | ns |
| t _H | SI, SCK, HOLD and CS Input Hold Time | 50 | | | ns |
| t _{RI} ⁽⁷⁾ | SI, SCK, HOLD and CS Input Rise Time | | | 2 | μs |
| t _{FI} ⁽⁷⁾ | SI, SCK, HOLD and CS Input Fall Time | | | 2 | μs |
| t _{DIS} | SO Output Disable Time | 0 | | 500 | ns |
| t _V | SO Output Valid Time | | | 150 | ns |
| t _{HO} | SO Output Hold Time | 0 | | | ns |
| t _{RO} | SO Output Rise Time | | 50 | | ns |
| t _{FO} | SO Output Fall Time | | 50 | | ns |
| t _{HOLD} | HOLD Time | 400 | | | ns |
| tHSU | HOLD Setup Time | 100 | | | ns |
| t _{HH} | HOLD Hold Time | 100 | | | ns |
| t _{HZ} | HOLD Low to Output in High Z | | 100 | | ns |
| t _{LZ} | HOLD High to Output in Low Z | | 100 | | ns |
| ТI | Noise Suppression Time Constant at SI, SCK, $\overline{\text{HOLD}}$ and $\overline{\text{CS}}$ inputs | | 20 | | ns |
| t _{CS} | CS Deselect Time | 2 | | | μs |
| twpasu | WP, A0 and A1 Setup Time | 0 | | | ns |
| t _{WPAH} | WP, A0 and A1 Hold Time | 0 | | | ns |

High-Voltage Write Cycle Timing

| SYMBOL | PARAMETER | TYP (NOTE 6) | MAX (NOTE 5) | UNITS |
|-----------------|--|-----------------|-----------------|-------|
| t _{WR} | High-voltage Write Cycle Time (Store Instructions) | 5 | 10 | ms |

XDCP Timing

| SYMBOL | PARAMETER | MIN (NOTE 5) | MAX (NOTE 5) | UNITS |
|-------------------|---|-----------------|-----------------|-------|
| twrpo | Wiper Response Time After The Power Supply Is Stable | | 10 | μs |
| t _{WRL} | Wiper Response Time After Instruction Issued (All Load Instructions) | | 10 | μs |
| ^t wrid | Wiper Response Time From An Active SCL/SCK Edge (Increment/Decrement Instruction) | | 10 | μs |

Symbol Table

| WAVEFORM | INPUTS | OUTPUTS |
|----------|-----------------------------------|-------------------------------------|
| | MUST BE STEADY | WILL BE STEADY |
| | MAY CHANGE FROM LOW TO HIGH | WILL CHANGE FROM LVD/TO HIGH |
| | MAY CHANGE FROM HIGH TO LOW | WILL CHANGE FROM HIGH TO LOW |
| | DON'T CARE: CHANGES ALLOWED | CHANGING: STATE NOT KNOWN |
| | N/A | CENTER LINE IS HIGH IMPEDANCE |

Timing Diagrams

Input Timing





Output Timing

Hold Timing



XDCP Timing (for All Load Instructions)







Write Protect and Device Address Pins Timing



Applications information

 Electronic potentiometers provide three powerful application advantages: The variability and reliability of a solid-state potentiometer,

Basic Configurations of Electronic Potentiometers



THREE TERMINAL POTENTIOMETER; VARIABLE VOLTAGE DIVIDER

- 2. The flexibility of computer-based digital controls)
- 3. the retentivity of nonvolatile memory used for the storage of multiple potentiometer settings or data.



TWO TERMINAL VARIABLE RESISTOR; VARIABLE CURRENT



Application Circuits

BUFFERED REFERENCE VOLTAGE

 $+V \xrightarrow{R_1} +5V \xrightarrow{+5V} V_W \xrightarrow{+5V} V_{OUT} = V_W$

CASCADING TECHNIQUES

v_w

OFFSET VOLTAGE ADJUSTMENT

٧w

(b)

+ν

(a)

NONINVERTING AMPLIFIER



VOLTAGE REGULATOR



 V_{O} (REG) = 1.25V (1+R₂/R₁)+I_{adj} R₂



COMPARATOR WITH HYSTERITISIS



Thin Shrink Small Outline Plastic Packages (TSSOP)



NOTES:

- 1. These package dimensions are within allowable dimensions of JEDEC MO-153-AC, Issue E.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- Dimension "E1" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.15mm (0.006 inch) per side.
- 5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- 9. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.08mm (0.003 inch) total in excess of "b" dimension at maximum material condition. Minimum space between protrusion and adjacent lead is 0.07mm (0.0027 inch).
- 10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact. (Angles in degrees)

M14.173

14 LEAD THIN SHRINK SMALL OUTLINE PLASTIC PACKAGE

| | INCHES | | MILLIMETERS | | |
|--------|----------------|----------------|----------------|----------------|-------|
| SYMBOL | MIN | MAX | MIN | MAX | NOTES |
| А | - | 0.047 | - | 1.20 | - |
| A1 | 0.002 | 0.006 | 0.05 | 0.15 | - |
| A2 | 0.031 | 0.041 | 0.80 | 1.05 | - |
| b | 0.0075 | 0.0118 | 0.19 | 0.30 | 9 |
| С | 0.0035 | 0.0079 | 0.09 | 0.20 | - |
| D | 0.195 | 0.199 | 4.95 | 5.05 | 3 |
| E1 | 0.169 | 0.177 | 4.30 | 4.50 | 4 |
| е | 0.026 BSC | | 0.65 BSC | | - |
| Е | 0.246 | 0.256 | 6.25 | 6.50 | - |
| L | 0.0177 | 0.0295 | 0.45 | 0.75 | 6 |
| Ν | 14 | | 14 | | 7 |
| α | 0 ⁰ | 8 ⁰ | 0 ⁰ | 8 ⁰ | - |

Rev. 2 4/06

Small Outline Plastic Packages (SOIC)



NOTES:

- 1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
- 2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
- Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
- 4. Dimension "E" does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
- 5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
- 6. "L" is the length of terminal for soldering to a substrate.
- 7. "N" is the number of terminal positions.
- 8. Terminal numbers are shown for reference only.
- 9. The lead width "B", as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch)
- 10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

M16.3 (JEDEC MS-013-AA ISSUE C) 16 LEAD WIDE BODY SMALL OUTLINE PLASTIC PACKAGE

| | INCHES | | MILLIMETERS | | |
|--------|-----------|--------|-------------|-------|-------|
| SYMBOL | MIN | MAX | MIN | MAX | NOTES |
| A | 0.0926 | 0.1043 | 2.35 | 2.65 | - |
| A1 | 0.0040 | 0.0118 | 0.10 | 0.30 | - |
| В | 0.013 | 0.0200 | 0.33 | 0.51 | 9 |
| С | 0.0091 | 0.0125 | 0.23 | 0.32 | - |
| D | 0.3977 | 0.4133 | 10.10 | 10.50 | 3 |
| E | 0.2914 | 0.2992 | 7.40 | 7.60 | 4 |
| е | 0.050 BSC | | 1.27 BSC | | - |
| Н | 0.394 | 0.419 | 10.00 | 10.65 | - |
| h | 0.010 | 0.029 | 0.25 | 0.75 | 5 |
| L | 0.016 | 0.050 | 0.40 | 1.27 | 6 |
| Ν | 16 | | 16 | | 7 |
| α | 0° | 8° | 0° | 8° | - |

Rev. 1 6/05

© Copyright Intersil Americas LLC 2005-2009. All Rights Reserved. All trademarks and registered trademarks are the property of their respective owners.

For additional products, see www.intersil.com/en/products.html

Intersil products are manufactured, assembled and tested utilizing ISO9001 quality systems as noted in the quality certifications found at www.intersil.com/en/support/qualandreliability.html

Intersil products are sold by description only. Intersil may modify the circuit design and/or specifications of products at any time without notice, provided that such modification does not, in Intersil's sole judgment, affect the form, fit or function of the product. Accordingly, the reader is cautioned to verify that datasheets are current before placing orders. Information furnished by Intersil is believed to be accurate and reliable. However, no responsibility is assumed by Intersil or its subsidiaries for its use; nor for any infringements of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Intersil or its subsidiaries.

For information regarding Intersil Corporation and its products, see www.intersil.com

